

4-Lines, Bi-directional Ultra-low Capacitance ESD Protection Array

DESCRIPTIONS

The TESDH3V3B02P4Q2 is a design which includes ESD rated diode arrays to protect high speed data interfaces. It has been specifically designed to protect sensitive electronic components which are connected to data and transmission lines from over-voltage damage caused by Electrostatic Discharging (ESD).

TESDH3V3B02P4Q2 incorporates four pair of ultralow capacitance steering diodes. During transient conditions, the steering diodes direct the transient to either the internal ESD line. The internal unique design of clamping cell prevents over-voltage on the internal ESD line and on the I/O line, which is protecting any downstream components.

The TESDH3V3B02P4Q2 may be used to provide ESD protection up to $\pm 10 \text{kV}$ (contact discharge) according to IEC61000-4-2, and withstand peak pulse current up to 5.5A (8/20 μ s) according to IEC61000-4-5

FEATURES

- ESD protect for 4 line with bidirectional
- Provide ESD protection for each channel to IEC61000-4-2 (ESD) ±15kV (air), ±10kV (contact) IEC61000-4-5 (Lightning): 5.5A (8/20µs)
- Suitable for ±3.3V and below, operating voltage applications
- Ultra-low capacitance: C_J = 0.21pF(typ.)
- Ultra-low leakage current
- Low voltage: V_{CL} = 9V(typ.)@ I_{TLP} = 16A
- Protect one I/O line
- Fast turn-on and Low clamping voltage
- Moisture sensitivity level: level 3, per J-STD-020
- RoHS Compliant
- Halogen-Free according to IEC 61249-2-21

APPLICATION

- USB 3.0 and USB 3.1
- HDMI 1.3 .HDMI 1.4 and HDMI2.0
- SATA and eSATA
- DisplayPort interface
- Portable Electronics
- Notebooks



PACKAGE: DFN2510-10L	PIN	CONFI	GURAT	ION	CIRCUIT DIAGRAM
8	NC [10]	[9] [[2] [ND NC 8 7 7 3 4 4 ND 1/03	NC [6]	1 2 3, 8 4 5
•	PIN 1	I/O1	PIN 6	NC	
	PIN 2	1/02	PIN 7	NC	
	PIN 3	GND	PIN 8	GND	
	PIN 4	I/O3	PIN 9	NC	
	PIN 5	I/O4	PIN 10	NC	

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ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	
Peak pulse power (tp = 8/20µs)	P _{PK}	33	W	
Peak pulse current (tp = 8/20µs)	I _{PP}	5.5	А	
ESD according to IEC61000-4-2 air discharge	V	±15	kV	
ESD according to IEC61000-4-2 contact discharge	V _{ESD}	±10	kV	
Junction temperature	T _J	125	°C	
Operating temperature range	T _{OP}	-40 to +85	°C	
Storage temperature range	T _{STG}	-55 to +150	°C	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Reverse working voltage		V_{RWM}	-	-	3.3	V
Reverse breakdown voltage	$I_R = 100 \mu A, T_J = 25^{\circ}C$	V_{BR}	9	-	12	V
Reverse leakage current	$V_{RWM} = 3.3V, T_J = 25^{\circ}C$	I _R	-	-	100	nA
Clamping voltage ⁽¹⁾	$I_{PP} = 1A$, $tp = 8/20 \mu s$	V _C	-	-	3.5	V
	$I_{PP} = 5.5A$, $tp = 8/20\mu s$		-	-	6.0	V
Clamping voltage ⁽²⁾	$I_{TLP} = 16A, tp = 100ns$	V _{CL}	-	9	-	V
Junction capacitance	f = 1MHz, V _R = 1.5V	CJ	-	0.21	0.28	pF
Dynamic resistance ⁽²⁾	·	R _{DYN}	-	0.40	-	Ω

Notes:

- 1. Non-repetitive current pulse, according to IEC61000-4-5.
- 2. TLP parameter: Z_0 = 50 Ω , tp = 100ns, tr = 2ns, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

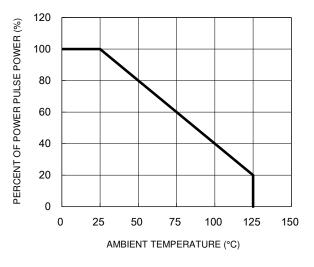
ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TESDH3V3B02P4Q2 RIG	DFN2510-10L	3,000 / 7" Tape & Reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Peak Pulse Power vs. Junction Temperature Fig.2 Non-Repetitive Peak Pulse Power vs. Pulse Time



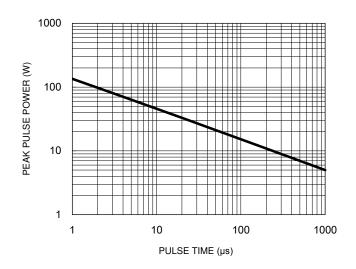
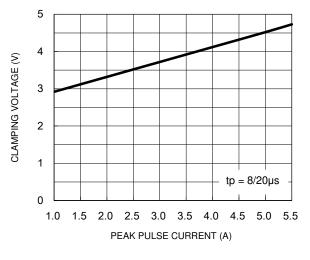


Fig.3 Clamping Voltage vs. Peak Pulse Current

Fig.4 Capacitance vs. Reverse Voltage



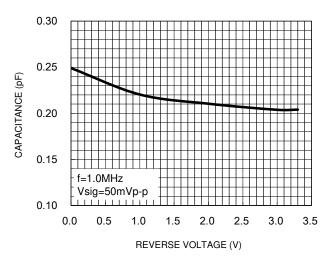
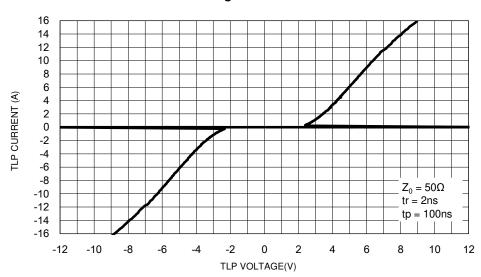


Fig.5 TLP Curve





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 8/20µs pulse waveform per IEC61000-4-5

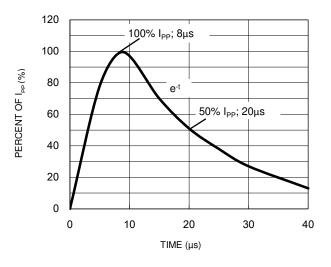
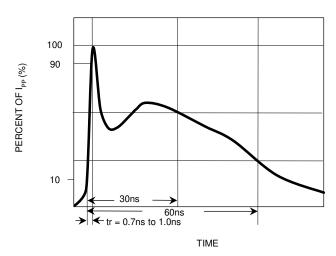


Fig.7 ESD pulse waveform per IEC61000-4-2





APPLICATION INFORMATION

Device Connection

The TESDH3V3B02P4Q2 is designed to protect four data lines from transient over-voltage (such as ESD stress pulse).

The usage of the TESDH3V3B02P4Q2 is shown in Fig.1.The four protected data lines are connected to the ESD protection pins (pin1, pin2, pin4, and pin5) of TESDH3V3B02P4Q2. The ground pins (pin3 and pin8) of TESDH3V3B02P4Q2 are the negative reference pins.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. These pins should be directly connected to the GND rail of PCB (Printed Circuit Board). To get minimum parasitic inductance, the path length should keep as short as possible.

TESDH3V3B02P4Q2 can provide ESD protection for 4 I/O signal lines simultaneously. If the number of I/O signal lines is less than 4, the unused I/O pins can be simply left as NC pins.

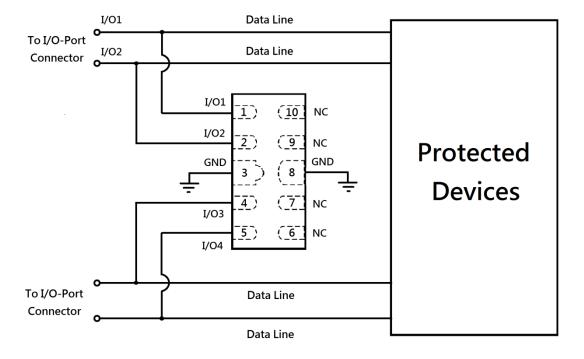
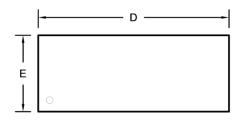


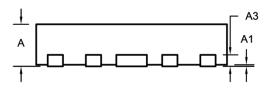
Fig.1 ESD protection by TESDH3V3B02P4Q2

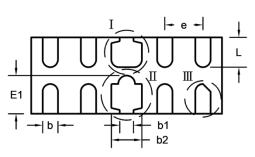


PACKAGE OUTLINE DIMENSIONS

DFN2510-10L











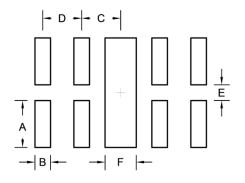






DIM. Unit (mm)		(mm)	Unit (inch)		
DIIVI.	Min.	Max.	Min.	Max.	
Α	0.50	0.60	0.020	0.024	
A1	0.00	0.05	0.000	0.002	
А3	0.15 Ref.		0.006 Ref.		
b	0.15	0.25	0.006	0.010	
b1	0.13	0.23	0.005	0.009	
b2	0.35	0.45	0.014	0.018	
D	2.40	2.60	0.094	0.102	
E	0.90	1.10	0.035	0.043	
E1	0.50 Ref.		0.020 Ref.		
е	0.50 BSC		0.020	0 BSC	
L	0.28	0.50	0.011	0.020	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	0.60	0.024
В	0.20	0.008
С	0.50	0.020
D	0.50	0.020
E	0.20	0.008
F	0.40	0.016

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



TG = Device Code YW = Date Code



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